

# **2SK2654-01** FAP-IIS Series

N-channel MOS-FET					
900V	$2\Omega$	8A	150W		

#### > Features

- High Speed Switching
- Low On-Resistance
- No Secondary Breakdown
- Low Driving Power
- High Voltage
- VGS = ± 30V Guarantee
- Repetitive Avalanche Rated

## > Applications

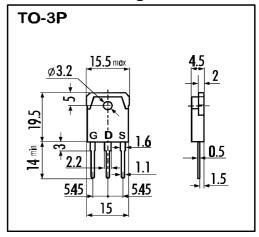
- Switching Regulators
- UPS
- DC-DC converters
- General Purpose Power Amplifier

### > Maximum Ratings and Characteristics

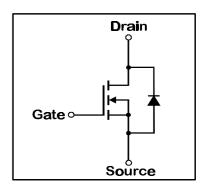
Absolute Maximum RatingsT( C=25°C), unless otherwise specified

Item	Symbol	Rating	Unit
Drain-Source-Voltage	V <sub>DS</sub>	900	V
Continous Drain Current	ΙD	8	Α
Pulsed Drain Current	I <sub>D(puls)</sub>	32	Α
Gate-Source-Voltage	V <sub>GS</sub>	±30	V
Repetitive or Non-Repetitive (T <sub>ch</sub> ≤ 150°C)	I AR	8	Α
Avalanche Energy	E AS	241	mJ
Max. Power Dissipation	P <sub>D</sub>	150	W
Operating and Storage Temperature Range	T ch	150	°C
	T <sub>stg</sub>	-55 ~ +150	°C

### > Outline Drawing



#### > Equivalent Circuit



- Electrical Characteristics (T<sub>C</sub>=25°C), unless otherwise specified

Item	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown-Voltage	V <sub>(BR)DSS</sub>	$I_D=1mA$ $V_{GS}=0V$	900			V
Gate Threshhold Voltage	V <sub>GS(th)</sub>	$I_D=1$ mA $V_{DS=}V_{GS}$	3,5	4,0	4,5	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}=900V$ $T_{ch}=25^{\circ}C$		10	500	μA
		$V_{GS}=0V$ $T_{ch}=125$ °C		0,2	1,0	mA
Gate Source Leakage Current	I <sub>GSS</sub>	$V_{GS}=\pm30V$ $V_{DS}=0V$		10	100	nA
Drain Source On-State Resistance	R <sub>DS(on)</sub>	$I_D=4A$ $V_{GS}=10V$		1,48	2,0	Ω
Forward Transconductance	g fs	$I_D=4A$ $V_{DS}=25V$		5		S
Input Capacitance	C iss	V <sub>DS</sub> =25V		1200		pF
Output Capacitance	C oss	V <sub>GS</sub> =0V		180		pF
Reverse Transfer Capacitance	C rss	f=1MHz		90		pF
Turn-On-Time t <sub>on</sub> (t <sub>on</sub> =t <sub>d(on)</sub> +t <sub>r</sub> )	t <sub>d(on)</sub>	V <sub>CC</sub> =600V		30		ns
	t r	I <sub>D</sub> =8A		120		ns
Turn-Off-Time t <sub>off</sub> (t <sub>on</sub> =t <sub>d(off)</sub> +t <sub>f</sub> )	t d(off)	V <sub>GS</sub> =10V		95		ns
	t f	$R_{GS}$ =10 $\Omega$		60		ns
Avalanche Capability	I AV	$L = 100 \mu H$ $T_{ch} = 25 ^{\circ} C$	8			Α
Diode Forward On-Voltage	V <sub>SD</sub>	$I_F=2xI_{DR}$ $V_{GS}=0V$ $T_{ch}=25$ °C		1,0		V
Reverse Recovery Time	t <sub>rr</sub>	$I_{F}=I_{DR}$ $V_{GS}=0V$		1000		ns
Reverse Recovery Charge	Q m	-dl $_{\text{F}}$ /dt=100A/ $\mu$ s T $_{\text{ch}}$ =25°C		12	_	μC

#### Thermal Characteristics

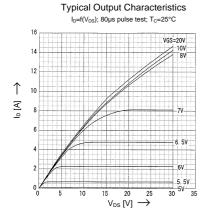
Thermal Onaracteristics						
Item	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Thermal Resistance	R <sub>th(ch-a)</sub>	channel to air			35	°C/W
	R th(ch-c)	channel to case			0,83	°C/W

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#### > Characteristics



50 T<sub>ch</sub> [°C]

